### **INDIUM CORPORATION®**

#### **PRODUCT DATA SHEET**

# **Flip-Chip Flux WS-580**

#### Features

- Halogen-free no intentionally added (NIA) halogens
- Designed for flip-chip dipping applications
- · Excellent solderability on a variety of metallizations
- Reduces flip-chip voids
- · Uniform dipping performance over extended periods
- Tackiness suitable for holding large die during assembly
- Bubble-free packaging

#### Introduction

Flip-Chip Flux WS-580 is a NIA halogen-free water washable flip-chip dipping flux which has an activator system powerful enough to promote wetting on the most demanding substrate metallizations.

#### **Properties**

Property	Value	Test Method
Flux Classification:	МО	J-STD-004 (IPC-TM-650: 2.3.32 and 2.3.33)
Typical Viscosity:	18 kcps	Brookfield HB DVII+-CP @ 5rpm after 5 min
SIR (Ohms, after cleaning):	Pass (>10 <sup>8</sup> after 7 days @ 85°C & 85% RH)	J-STD-004 (IPC-TM-650: 2.6.3.3 IPC-B-24)
Typical Acid Value:	93mg KOH/g	Titration
Shelf Life:	0-30 ° C for 6 months	Viscosity change/ microscope examination

All information is for reference only. Not to be used as incoming product specifications.

### **Application**

WS-580 is intended to be used in an air or nitrogen reflow environment of 100ppm oxygen or less. WS-580 can be used on many surface finishes including immersion Ag, Cu, and Ni. WS-580 has been developed to allow tin and tin/silver solderbumps, in both standard bump shapes and as microbumps on copper pillars, to solder well to any quality of substrate metallization. WS-580 also allows poor quality OSP to be soldered, without non-wet-open solder joints.



### **Dipping Process**

The dipping depth should be adjusted to exact needs. Guidelines are given in the illustration below. The flux reservoir (dip tray) should be cleaned and replenished every shift.



#### OVER→

Form No. 99228 (A4) R1

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## Flip-Chip Flux WS-580

#### Cleaning

**WS-580** residue can be cleaned with DI water, or water with an added cleaner. Ideal conditions for spray-cleaning: 25 °C (room temperature) to 40 °C for >1 minute at 60psi or higher.

#### Packaging

**WS-580** is available airlessly packaged in 10cc and 30cc syringes, and is also available in jars or cartridges, on customer request.

#### **Storage**

For maximum shelf life, **WS-580** syringes and cartridges should be stored tip down. Storage temperatures should not exceed 30°C. If using cold storage, **WS-580** should be allowed to stand for at least 4 hours at room temperature before using.

#### **Technical Support**

Indium Corporation sets the industry standard in providing rapid response, on-site technical support for our customers worldwide. Indium Corporation's team of Technical Support Engineers can provide expertise in all aspects of materials science and semiconductor packaging process applications.

#### **Safety Data Sheets**

The SDS for this product can be found online at http://www.indium.com/sds

#### Reflow



Flip-Chip Flux WS-580 is intended to be used in a nitrogen reflow environment of 100ppm oxygen or less. Some applications can utilize this material in an air environment, although best results will be obtained in an inert atmosphere. Flip-Chip Flux WS-580 can be used on many surface finishes.

This product data sheet is provided for general information only. It is not intended, and shall not be construed, to warrant or guarantee the performance of the products described which are sold subject exclusively to written warranties and limitations thereon included in product packaging and invoices. All Indium Corporation's products and solutions are designed to be commercially available unless specifically stated otherwise.

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